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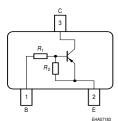


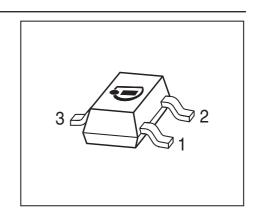
## **PNP Silicon Digital Transistor**

- Built in bias resistor ( $R_1$ = 2.2 k $\Omega$ ,  $R_2$ = 10 k $\Omega$ )
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101









Туре	Marking	Pin Configuration P			Package
BCR555	XDs	1=B	2=E	3=C	SOT23

## **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	50	V
Collector-base voltage	$V_{CBO}$	50	
Input forward voltage	V <sub>i(fwd)</sub>	20	
Input reverse voltage	V <sub>i(rev)</sub>	5	
Collector current	I <sub>C</sub>	500	mA
Total power dissipation-	P <sub>tot</sub>	330	mW
<i>T</i> <sub>S</sub> ≤ 79 °C			
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature	$T_{ m stg}$	-65 150	

### **Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	R <sub>thJS</sub>	≤ 215	K/W

1

 $<sup>^{1}</sup>$ For calculation of  $R_{thJA}$  please refer to Application Note AN077 (Thermal Resistance Calculation)



**Electrical Characteristics** at  $T_A = 25$ °C, unless otherwise specified

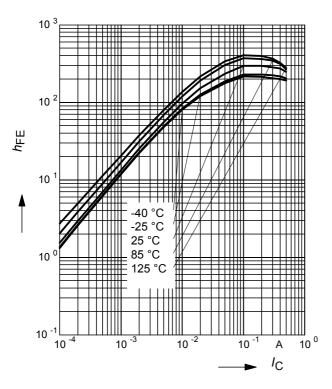
Parameter	Symbol		Values		
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage	V <sub>(BR)CEO</sub>	50	-	-	V
$I_{\rm C} = 100 \ \mu \text{A}, \ I_{\rm B} = 0$					
Collector-base breakdown voltage	V <sub>(BR)CBO</sub>	50	-	-	
$I_{\rm C} = 10 \ \mu {\rm A}, \ I_{\rm E} = 0$					
Collector-base cutoff current	I <sub>CBO</sub>	-	-	100	nA
$V_{\rm CB} = 50 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I <sub>EBO</sub>	-	-	0.65	mA
$V_{EB} = 5 \text{ V}, I_{C} = 0$					
DC current gain-	h <sub>FE</sub>	70	-	-	-
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 5 V					
Collector-emitter saturation voltage <sup>1)</sup>	V <sub>CEsat</sub>	-	-	0.3	V
$I_{\rm C}$ = 50 mA, $I_{\rm B}$ = 2.5 mA					
Input off voltage	V <sub>i(off)</sub>	0.4	-	1	
$I_{\rm C}$ = 100 $\mu$ A, $V_{\rm CE}$ = 5 V					
Input on voltage	V <sub>i(on)</sub>	0.5	-	1.4	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 0.3 V					
Input resistor	R <sub>1</sub>	1.5	2.2	2.9	kΩ
Resistor ratio	$R_1/R_2$	0.19	0.22	0.24	-
AC Characteristics	•		·	·	
Transition frequency	f <sub>T</sub>	-	150	-	MHz
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 5 V, $f$ = 100 MHz					

<sup>&</sup>lt;sup>1</sup>Pulse test:  $t < 300\mu s$ ; D < 2%



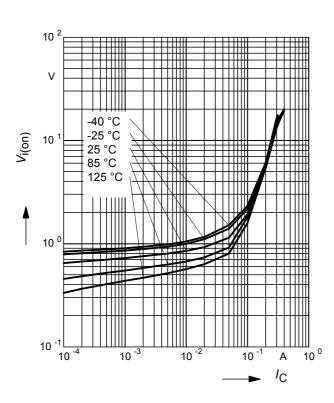
## **DC** current gain $h_{FE} = f(I_C)$

 $V_{CE}$  = 5 V (common emitter configuration)



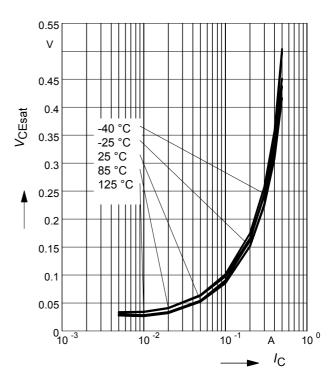
# Input on Voltage $Vi_{(On)} = f(I_C)$

 $V_{CE}$  = 0.3V (common emitter configuration)



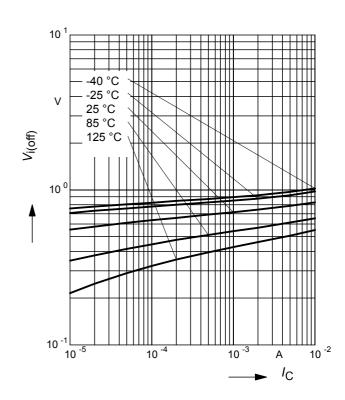
### Collector-emitter saturation voltage

 $V_{CEsat} = f(I_{C}), I_{C}/I_{B} = 20$ 



## Input off voltage $V_{i(Off)} = f(I_C)$

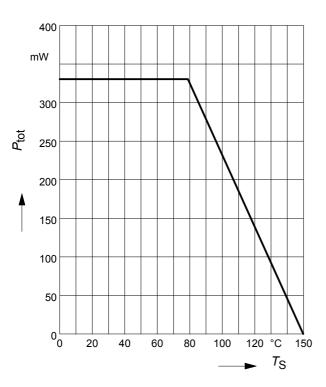
 $V_{CE}$  = 5V (common emitter configuration)

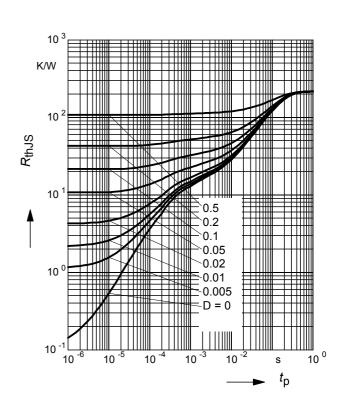




## Total power dissipation $P_{tot} = f(T_S)$

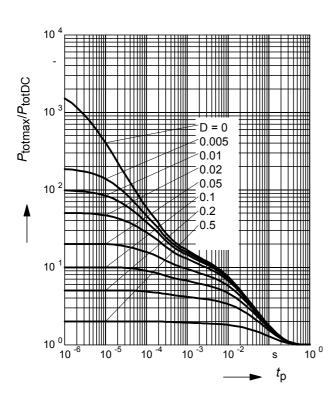
## Permissible Pulse Load $R_{thJS} = f(t_p)$





## **Permissible Pulse Load**

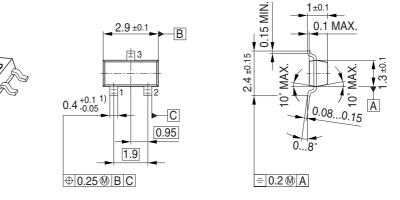
$$P_{\text{totmax}}/P_{\text{totDC}} = f(t_{p})$$



4

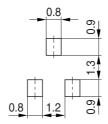


## Package Outline

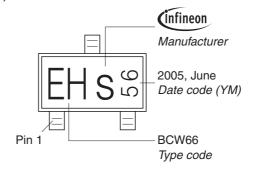


1) Lead width can be 0.6 max. in dambar area

### Foot Print

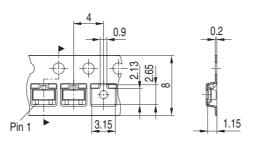


## Marking Layout (Example)



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel



5



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6

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